

MC100LVEL39

3.3V ECL $\div 2/4$, $\div 4/6$ Clock Generation Chip

The MC100LVEL39 is a low skew $\div 2/4$, $\div 4/6$ clock generation chip designed explicitly for low skew clock generation applications. The internal dividers are synchronous to each other, therefore, the common output edges are all precisely aligned. The device can be driven by either a differential or single-ended input signal. In addition, by using the V_{BB} output, a sinusoidal source can be AC coupled into the device.

The common enable ($\overline{EN}$) is synchronous so that the internal dividers will only be enabled/disabled when the internal clock is already in the LOW state. This avoids any chance of generating a runt clock pulse on the internal clock when the device is enabled/disabled as can happen with an asynchronous control. An internal runt pulse could lead to losing synchronization between the internal divider stages. The internal enable flip-flop is clocked on the falling edge of the input clock, therefore, all associated specification limits are referenced to the negative edge of the clock input.

Upon startup, the internal flip-flops will attain a random state; therefore, for systems which utilize multiple LVEL39s, the master reset (MR) input must be asserted to ensure synchronization. For systems which only use one LVEL39, the MR pin need not be exercised as the internal divider design ensures synchronization between the $\div 2/4$ and the $\div 4/6$ outputs of a single device.

The V_{BB} pin, an internally generated voltage supply, is available to this device only. For single-ended input conditions, the unused differential input is connected to V_{BB} as a switching reference voltage. V_{BB} may also rebias AC coupled inputs. When used, decouple V_{BB} and V_{CC} via a 0.01 μ F capacitor and limit current sourcing or sinking to 0.5 mA. When not used, V_{BB} should be left open.

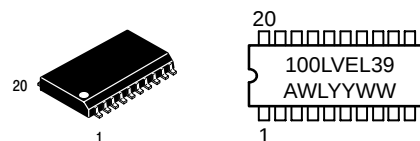
- 50 ps Maximum Output-to-Output Skew
- Synchronous Enable/Disable
- Master Reset for Synchronization
- ESD Protection: >2 KV HBM
- The 100 Series Contains Temperature Compensation
- PECL Mode Operating Range: V_{CC} = 3.0 V to 3.8 V with V_{EE} = 0 V
- NECL Mode Operating Range: V_{CC} = 0 V with V_{EE} = -3.0 V to -3.8 V
- Internal Input Pulldown Resistors
- Meets or Exceeds JEDEC Spec EIA/JESD78 IC Latchup Test
- Moisture Sensitivity Level 1
For Additional Information, see Application Note AND8003/D
- Flammability Rating: UL-94 code V-0 @ 1/8",
Oxygen Index 28 to 34
- Transistor Count = 419 devices



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MARKING DIAGRAM*



SOIC-20
DW SUFFIX
CASE 751D

A = Assembly Location
WL = Wafer Lot
YY = Year
WW = Work Week

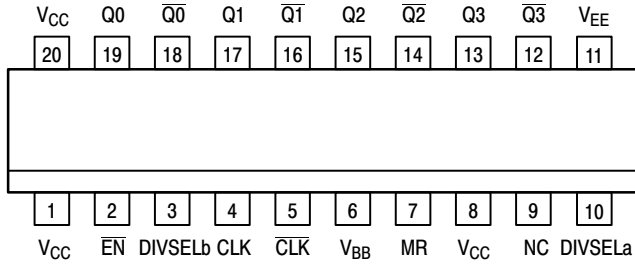
*For additional information, see Application Note
AND8002/D

ORDERING INFORMATION

Device	Package	Shipping
MC100LVEL39DW	SOIC-20	38 Units/Rail
MC100LVEL39DWR2	SOIC-20	1000 Units/Reel

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Pinout: 20-Lead SOIC (Top View)



Warning: All V_{CC} and V_{EE} pins must be externally connected to Power Supply to guarantee proper operation.

FUNCTION TABLE

CLK	$\overline{EN}$	MR	FUNCTION
Z	L	L	Divide
ZZ	H	L	Hold Q_{0-3}
X	X	H	Reset Q_{0-3}

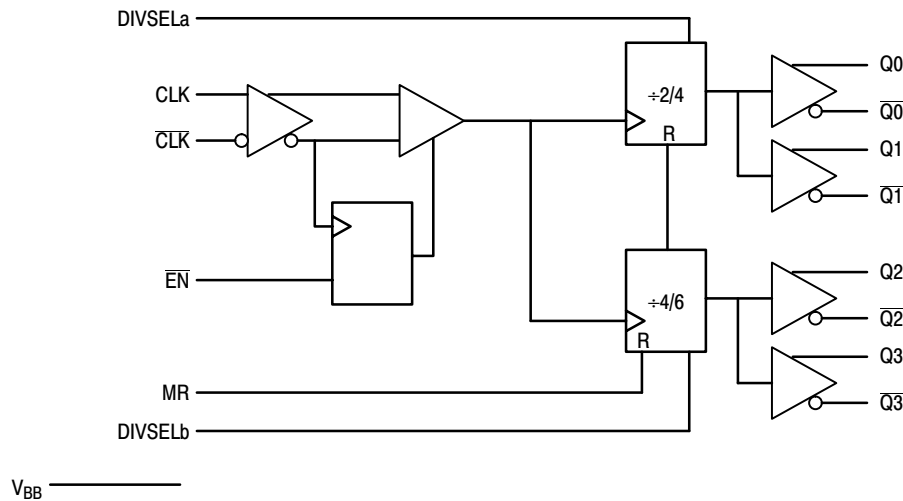
Z = Low-to-High Transition
ZZ = High-to-Low Transition
X = Don't Care

PIN DESCRIPTION

PIN	FUNCTION
CLK, $\overline{CLK}$	ECL Diff Clock Inputs
$Q_0, Q_1; \overline{Q_0}, \overline{Q_1}$	ECL Diff +2/4 Outputs
$Q_2, Q_3; \overline{Q_2}, \overline{Q_3}$	ECL Diff +4/6 Outputs
DIVSELa, DIVSELb	ECL Frequency Select Inputs
$\overline{EN}$	ECL Sync Enable
MR	ECL Master Reset
V_{BB}	Reference Voltage Output
V_{CC}	Positive Supply
V_{EE}	Negative Supply
NC	No Connect

DIVSELa	Q_0, Q_1 OUTPUTS
L	Divide by 2
H	Divide by 4
DIVSELb	Q_2, Q_3 OUTPUTS
L	Divide by 4
H	Divide by 6

LOGIC DIAGRAM



MC100LVEL39

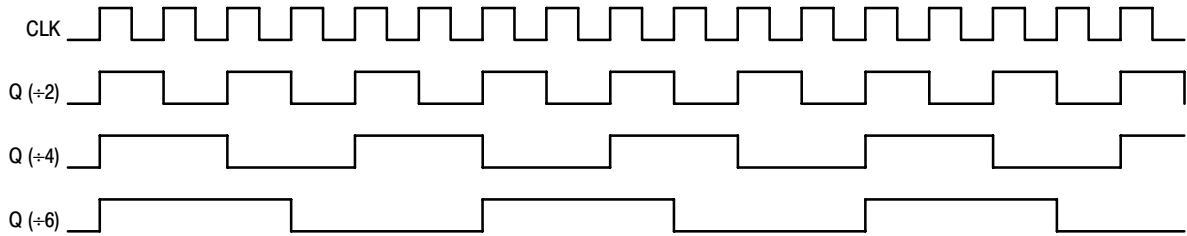


Figure 1. Timing Diagrams

MAXIMUM RATINGS (Note 1.)

Symbol	Parameter	Condition 1	Condition 2	Rating	Units
V _{CC}	PECL Mode Power Supply	V _{EE} = 0 V		8 to 0	V
V _{EE}	NECL Mode Power Supply	V _{CC} = 0 V		–8 to 0	V
V _I	PECL Mode Input Voltage	V _{EE} = 0 V	V _I ≤ V _{CC}	6 to 0	V
	NECL Mode Input Voltage	V _{CC} = 0 V	V _I ≥ V _{EE}	–6 to 0	V
I _{out}	Output Current	Continuous Surge		50 100	mA mA
I _{BB}	V _{BB} Sink/Source			± 0.5	mA
TA	Operating Temperature Range			–40 to +85	°C
T _{stg}	Storage Temperature Range			–65 to +150	°C
θ _{JA}	Thermal Resistance (Junction to Ambient)	0 LFPM 500 LFPM	20 SOIC 20 SOIC	90 60	°C/W °C/W
θ _{JC}	Thermal Resistance (Junction to Case)	std bd	20 SOIC	30 to 35	°C/W
T _{sol}	Wave Solder	<2 to 3 sec @ 248°C		265	°C

1. Maximum Ratings are those values beyond which device damage may occur.

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LVPECL DC CHARACTERISTICS $V_{CC}=3.3\text{ V}$; $V_{EE}=0.0\text{ V}$ (Note 1)

Symbol	Characteristic	-40°C			25°C			85°C			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
I_{EE}	Power Supply Current		50	59		50	59		54	61	mA
V_{OH}	Output HIGH Voltage (Note 2.)	2215	2295	2420	2275	2345	2420	2275	2345	2420	mV
V_{OL}	Output LOW Voltage (Note 2.)	1470	1605	1745	1490	1595	1680	1490	1595	1680	mV
V_{IH}	Input HIGH Voltage (Single Ended)	2135		2420	2135		2420	2135		2420	mV
V_{IL}	Input LOW Voltage (Single Ended)	1490		1825	1490		1825	1490		1825	mV
V_{BB}	Output Voltage Reference	1.92		2.04	1.92		2.04	1.92		2.04	V
V_{IHCMR}	Input HIGH Voltage Common Mode Range (Differential) (Note 3.)										
	$V_{pp} < 500\text{ mV}$	1.3		2.9	1.2		2.9	1.2		2.9	V
	$V_{pp} \geq 500\text{ mV}$	1.5		2.9	1.4		2.9	1.4		2.9	V
I_{IH}	Input HIGH Current			150			150			150	μA
I_{IL}	Input LOW Current	0.5			0.5			0.5			μA

NOTE: Devices are designed to meet the DC specifications shown in the above table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lfm is maintained.

1. Input and output parameters vary 1:1 with V_{CC} . V_{EE} can vary $\pm 0.3\text{ V}$.
2. Outputs are terminated through a 50 ohm resistor to $V_{CC}-2\text{ volts}$.
3. V_{IHCMR} min varies 1:1 with V_{EE} , max varies 1:1 with V_{CC} . The V_{IHCMR} range is referenced to the most positive side of the differential input signal. Normal operation is obtained if the HIGH level falls within the specified range and the peak-to-peak voltage lies between V_{ppmin} and 1 V.

LVNECL DC CHARACTERISTICS $V_{CC}=0.0\text{ V}$; $V_{EE}=-3.3\text{ V}$ (Note 1.)

Symbol	Characteristic	-40°C			25°C			85°C			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
I_{EE}	Power Supply Current		50	59		50	59		54	61	mA
V_{OH}	Output HIGH Voltage (Note 2.)	-1085	-1005	-880	-1025	-955	-880	-1025	-955	-880	mV
V_{OL}	Output LOW Voltage (Note 2.)	-1830	-1695	-1555	-1810	-1705	-1620	-1810	-1705	-1620	mV
V_{IH}	Input HIGH Voltage (Single Ended)	-1165		-880	-1165		-880	-1165		-880	mV
V_{IL}	Input LOW Voltage (Single Ended)	-1810		-1475	-1810		-1475	-1810		-1475	mV
V_{BB}	Output Voltage Reference	-1.38		-1.26	-1.38		-1.26	-1.38		-1.26	V
V_{IHCMR}	Input HIGH Voltage Common Mode Range (Differential) (Note 3.)										
	$V_{pp} < 500\text{ mV}$	-2.0		-0.4	-2.1		-0.4	-2.1		-0.4	V
	$V_{pp} \geq 500\text{ mV}$	-1.8		-0.4	-1.9		-0.4	-1.9		-0.4	V
I_{IH}	Input HIGH Current			150			150			150	μA
I_{IL}	Input LOW Current	0.5			0.5			0.5			μA

NOTE: Devices are designed to meet the DC specifications shown in the above table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lfm is maintained.

1. Input and output parameters vary 1:1 with V_{CC} . V_{EE} can vary $\pm 0.3\text{ V}$.
2. Outputs are terminated through a 50 ohm resistor to $V_{CC}-2\text{ volts}$.
3. V_{IHCMR} min varies 1:1 with V_{EE} , max varies 1:1 with V_{CC} . The V_{IHCMR} range is referenced to the most positive side of the differential input signal. Normal operation is obtained if the HIGH level falls within the specified range and the peak-to-peak voltage lies between V_{ppmin} and 1 V.

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AC CHARACTERISTICS $V_{CC}= 3.3\text{ V}$; $V_{EE}= 0.0\text{ V}$ or $V_{CC}= 0.0\text{ V}$; $V_{EE}= -3.3\text{ V}$ (Note 1.)

Symbol	Characteristic	-40°C			25°C			85°C			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
$f_{\max}$	Maximum Toggle Frequency	1000			1000			1000			MHz
t_{PLH} t_{PHL}	Propagation Delay CLK to Q (Diff) CLK to Q (S.E.) MR to Q	760 710 600		960 1010 900	800 750 610		1000 1050 910	850 800 630		1050 1100 930	ps
t_{SKEW}	Within-Device Skew (Note 2.) $Q_0 - Q_3$			50			50			50	ps
	Part-to-Part $Q_0 - Q_3$ (Diff)			200			200			200	ps
t_{JITTER}	Cycle-to-Cycle Jitter		TBD			TBD			TBD		ps
t_S	Setup Time $\overline{EN}$ to $\overline{CLK}$	250			250			250			ps
	$DIVSEL$ to $\overline{CLK}$	400			400			400			ps
t_H	Hold Time $\overline{CLK}$ to $\overline{EN}$	100			100			100			ps
	$\overline{CLK}$ to Div_Sel	150			150			150			ps
V_{PP}	Input Swing (Note 3.) CLK	250		1000	250		1000	250		1000	mV
t_{RR}	Reset Recovery Time			100			100			100	ps
t_{PW}	Minimum Pulse Width CLK	500			500			500			ps
	MR	700			700			700			ps
t_r, t_f	Output Rise/Fall Times Q (20% – 80%)	280		550	280		550	280		550	ps

1. V_{EE} can vary $\pm 0.3\text{ V}$.
2. Skew is measured between outputs under identical transitions.
3. $V_{PP}(\min)$ is minimum input swing for which AC parameters are guaranteed. The device will function reliably with differential inputs down to 100 mV.

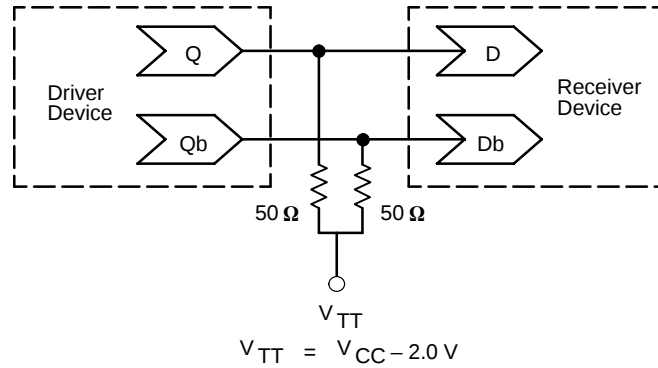


Figure 2. Typical Termination for Output Driver and Device Evaluation
(See Application Note AND8020 – Termination of ECL Logic Devices.)

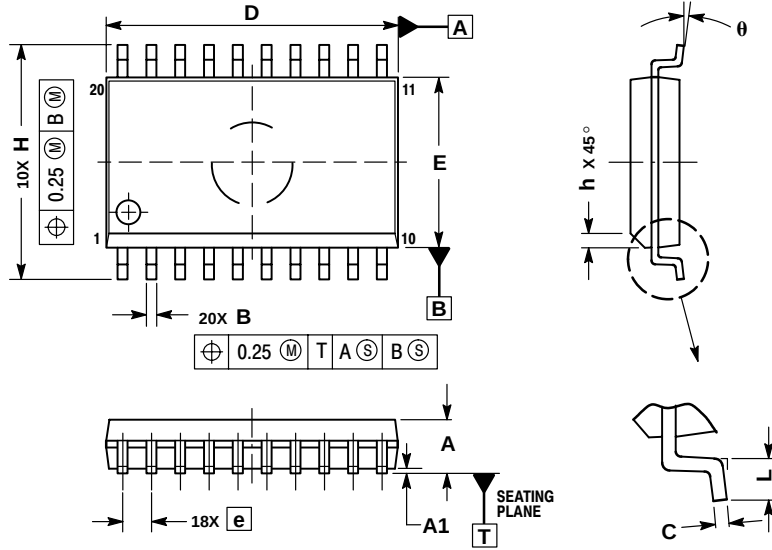
Resource Reference of Application Notes

- AN1404** – ECLinPS Circuit Performance at Non–Standard V_{IH} Levels
- AN1405** – ECL Clock Distribution Techniques
- AN1406** – Designing with PECL (ECL at +5.0 V)
- AN1503** – ECLinPS I/O SPICE Modeling Kit
- AN1504** – Metastability and the ECLinPS Family
- AN1560** – Low Voltage ECLinPS SPICE Modeling Kit
- AN1568** – Interfacing Between LVDS and ECL
- AN1596** – ECLinPS Lite Translator ELT Family SPICE I/O Model Kit
- AN1650** – Using Wire–OR Ties in ECLinPS Designs
- AN1672** – The ECL Translator Guide
- AND8001** – Odd Number Counters Design
- AND8002** – Marking and Date Codes
- AND8020** – Termination of ECL Logic Devices

MC100LVEL39

PACKAGE DIMENSIONS

SOIC-20
DW SUFFIX
PLASTIC SOIC PACKAGE
CASE 751D-05
ISSUE F



NOTES:

1. DIMENSIONS ARE IN MILLIMETERS.
2. INTERPRET DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994.
3. DIMENSIONS D AND E DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.
5. DIMENSION B DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE PROTRUSION SHALL BE 0.13 TOTAL IN EXCESS OF B DIMENSION AT MAXIMUM MATERIAL CONDITION.

DIM	MILLIMETERS	
	MIN	MAX
A	2.35	2.65
A1	0.10	0.25
B	0.35	0.49
C	0.23	0.32
D	12.65	12.95
E	7.40	7.60
e	1.27 BSC	
H	10.05	10.55
h	0.25	0.75
L	0.50	0.90
θ	0°	7°

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